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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Akira TSUKAMOTO	10/20/2011
Seiji ADACHI	10/20/2011
Yasuo OSHIKUBO	10/20/2011
Keiichi TANABE	10/20/2011

RECEIVING PARTY DATA

Name:	International Superconductivity Technology Center	
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City:	Tokyo	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13326966

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ATTORNEY DOCKET NUMBER: 107865.64143US

NAME OF SUBMITTER: Michael H. Jacobs

Total Attachments: 1

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PATENT REEL: 027501 FRAME: 0926 P \$40.00 1332696

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by International Superconductivity Technology Center, a corporation organized under the laws of Japan, located at 10-13, Shinonome 1-chome, Koto-ku, Tokyo 135-0062, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said International Superconductivity Technology Center, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

HIGH-TEMPERATURE SUPERCONDUCTING MAGNETIC SENSOR AND FABRICATION METHOD OF THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said International Superconductivity Technology Center, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said International Superconductivity Technology Center.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
. 1)	akina Tsukamoto	2011/10/20
.,	Akira TSUKAMOTO	
2)	Seifi Adachi	Oct. 20, 2011
•	Seiji ADACHI	
3)	Yasuo Oshikubo	201//10/20
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4)	Keichi Zanabe	Oct. 20, 2011
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